Test facilities for phase-1 pixel upgrade at CERN

Stefano Mersi
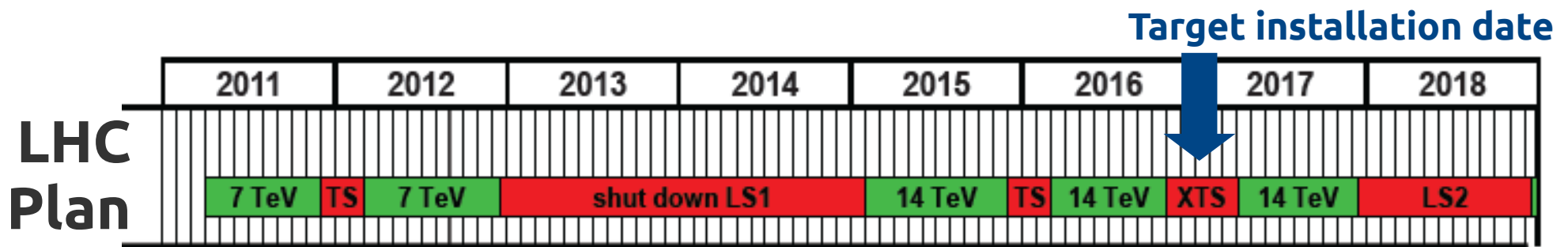
Introduction

Outline

- CMS Pixel Phase-1 upgrade introduction

- Test systems @CERN (building 186)

  – Beam test preparation

  – Production/calibration measurements

  – Small system integration tests

  – Cooling plant

- Future activities @CERN (building 186)
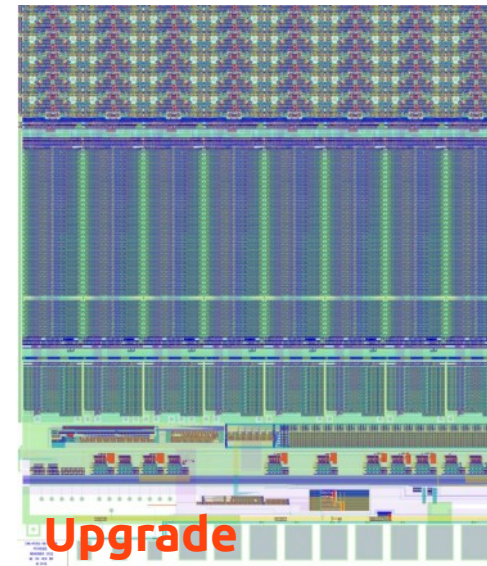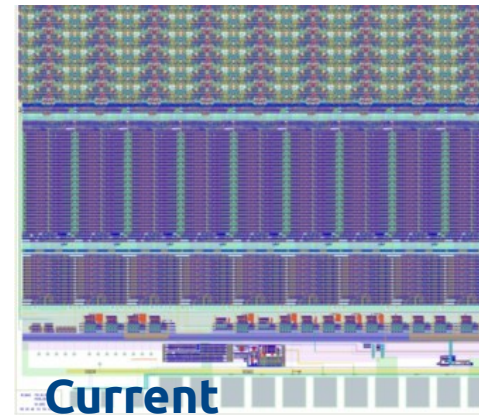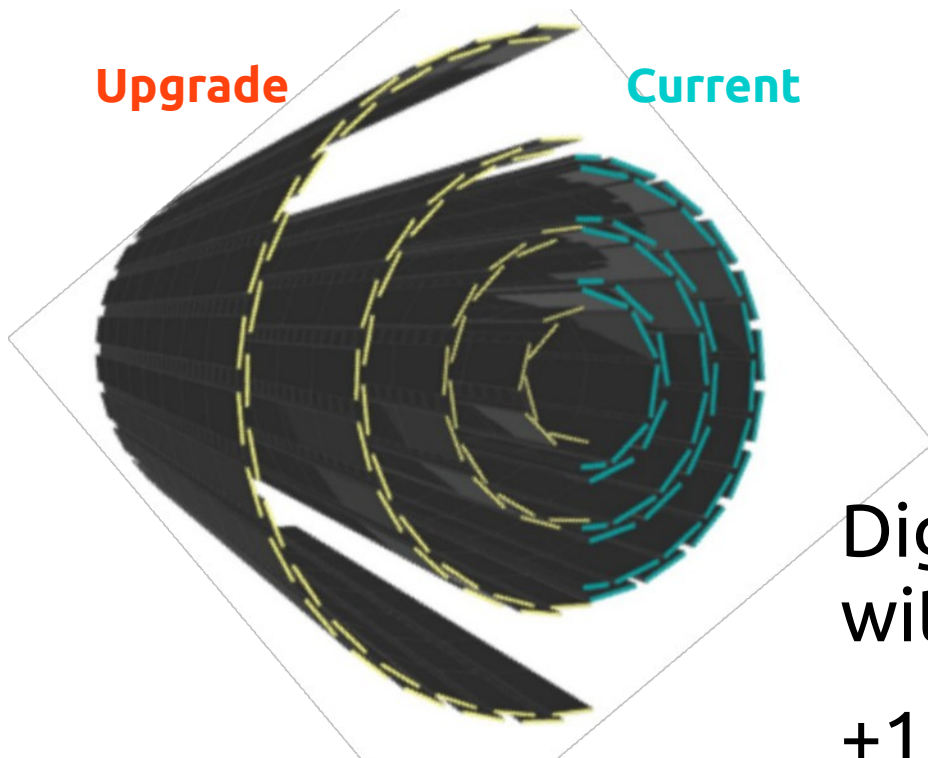
Not covering:

- Activities at the experiment site (P5)

  – Cooling

  – DAQ integration

- Optical links and DAQ hardware development and tests (PH-ESE)

CMS Pixel Phase-1 upgrade

- Present detector :
  - Proposed in 1995 for max instantaneous $L = 1 \times 10^{34}$ Hz cm^{-2}
  - Good performance in Run 1: $\sigma_{r\phi}=10$ µm , $\sigma_z=20-40$ µm, $\varepsilon>99\%$
  - Possible high dead-time (~50% @ 2×10^{34} Hz cm^{-2} & 50 ns BX spacing)

- Upgrade detector
  - Lower dead-time (new ROC) & improved geometry
  - Baseline $L=2 \times 10^{34}$ Hz cm^{-2} & 25 ns (50 pileup) and tolerate same luminosity but 50 ns (100 pileup)
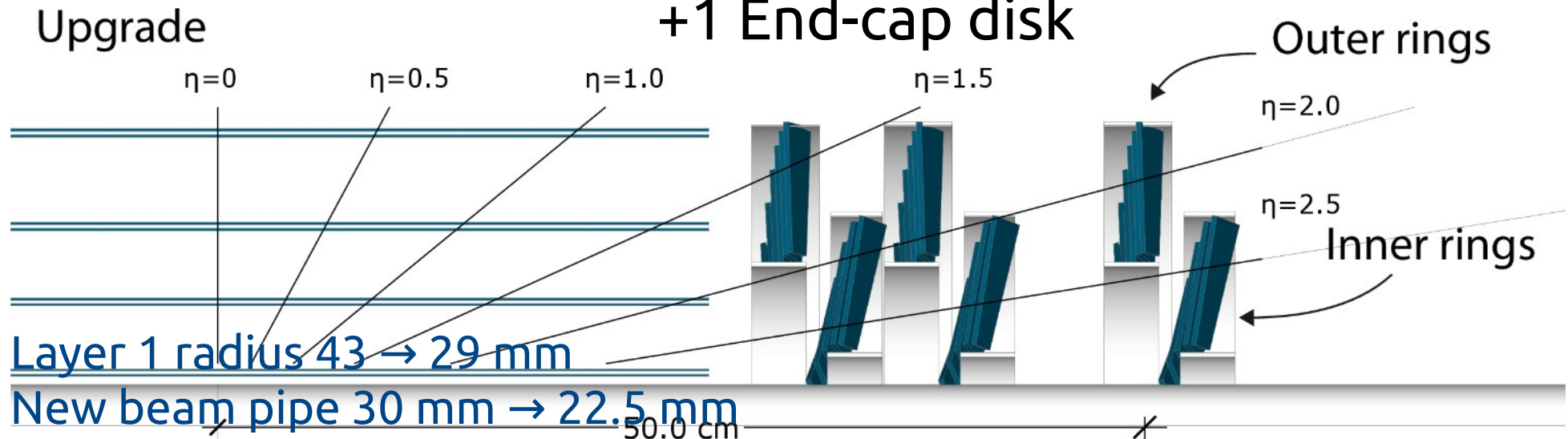 - Serve integrated Luminosity of 500 fb^{-1} (250 fb^{-1} for L1)

CMS Pixel Phase-1 upgrade

Upgrade　　**Current**

Current

Upgrade

Digital Read-Out Chip
with increased rate capability

+1 Barrel layer
+1 End-cap disk

Upgrade

$\eta=0$　　$\eta=0.5$　　$\eta=1.0$　　$\eta=1.5$　　$\eta=2.0$

Outer rings

$\eta=2.5$

Inner rings

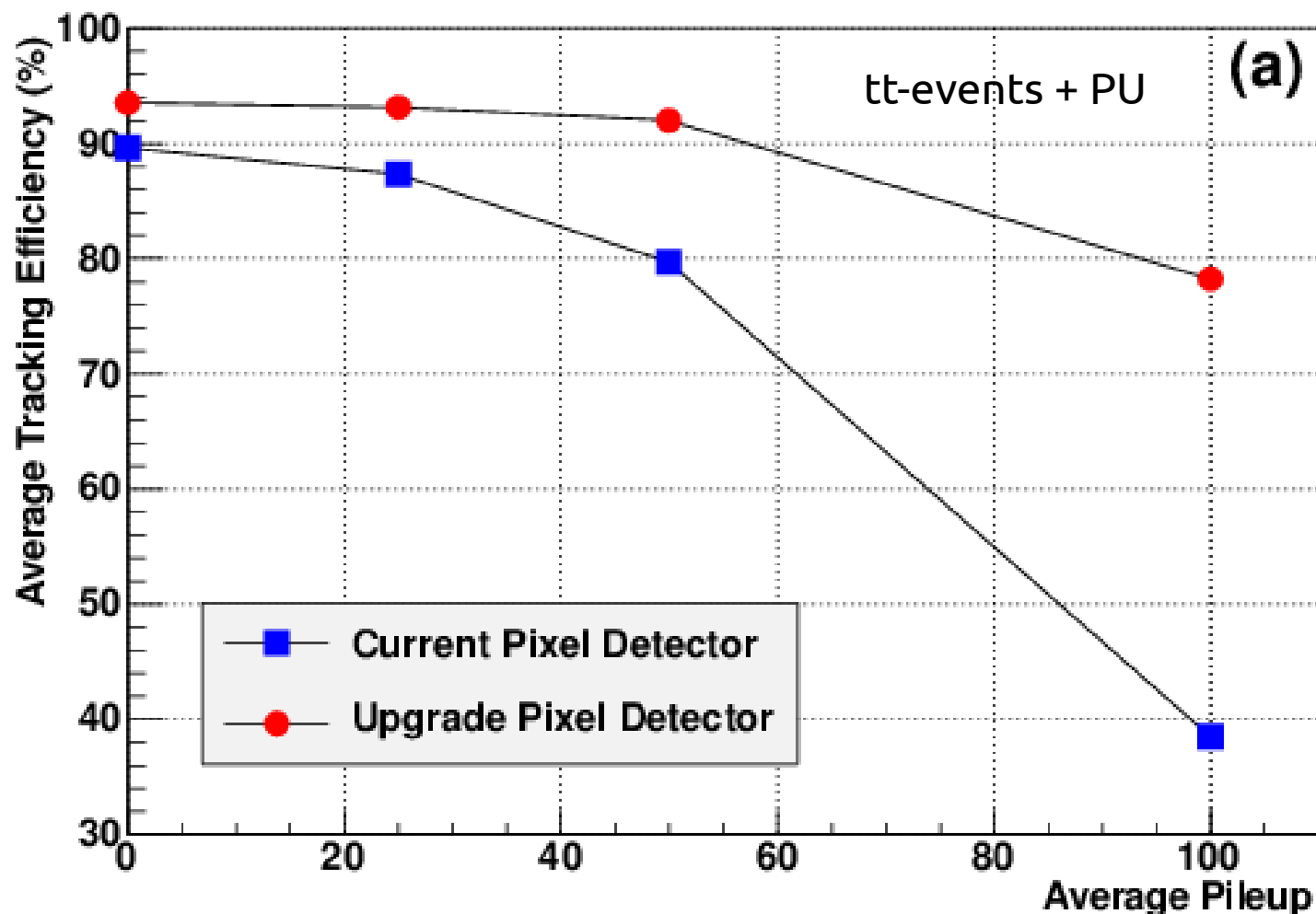Layer 1 radius 43 → 29 mm
New beam pipe 30 mm → 22.5 mm

50.0 cm

CMS Pixel Phase-1 upgrade
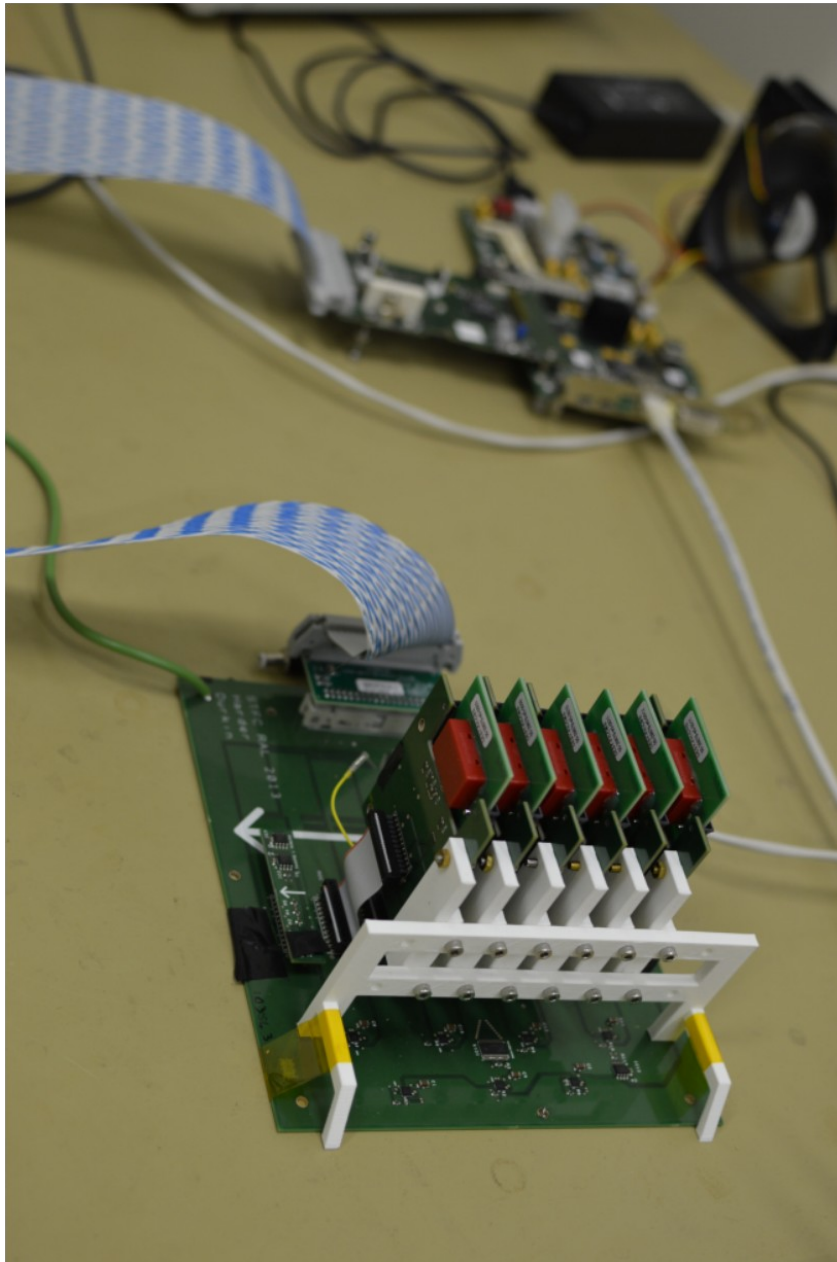
+1 detector layer

Improved Read-Out Chip
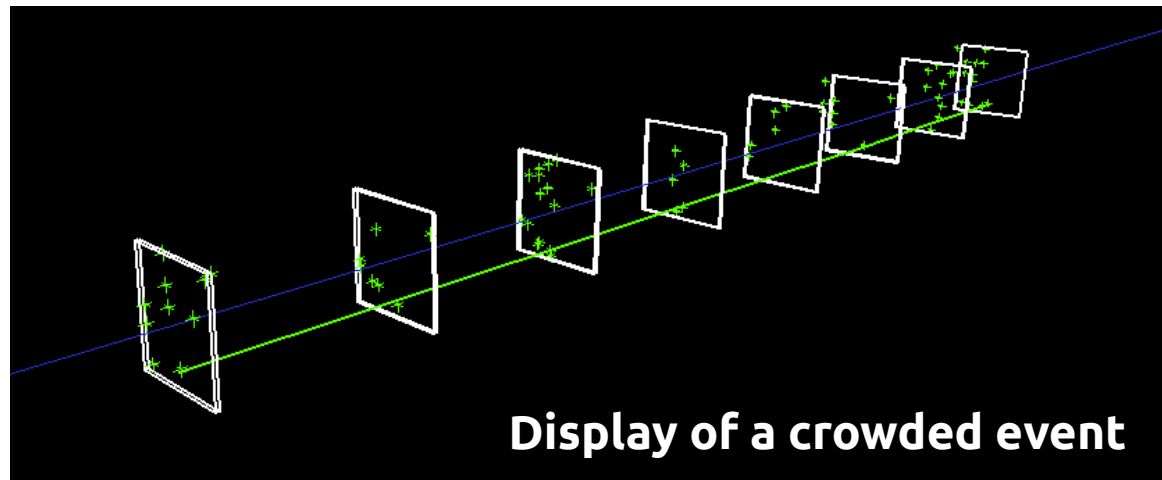
Greatly improved
performance at high pile-up

CMS Pixel Phase-1 activities at CERN

- Beam test to qualify the new read-out chip

  Past

- Module construction

  - Component testing

  - Mechanical assembly, wire-bonding

  - Functional tests (thermal cycling, calibration)

  Present

- System integration (small systems)

  - DAQ hardware

  - DAQ software

  - New components

- Cooling plant prototype

  (Near) Future

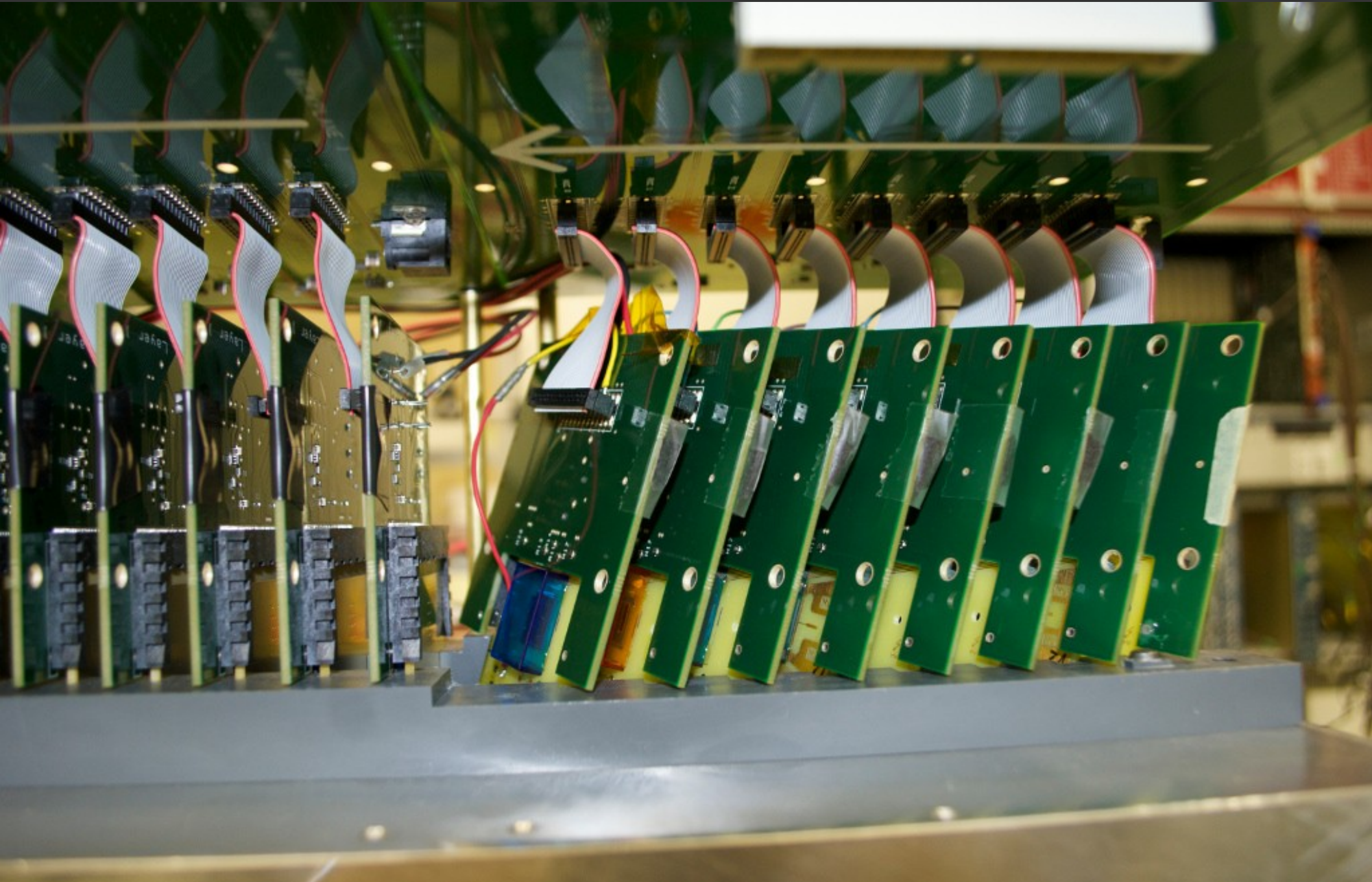- Large-scale integration test (towards final system)

Beam tests

- NTU+RAL+CERN performed a series of beam tests (at PSI, FNAL & CERN) to assess the performance of the new Read-Out Chip in a high-rate environment

- An ad-hoc telescope made of PSI46dig ROC chips was built and the corresponding DAQ was set-up

- The DAQ is based on a Xilinx evaluation board and is read via IPBus (just like the local readout of the new μTCA back-end cards!)

- The set-up is still available and can be used as a telescope

Display of a crowded event

Beam tests – telescope in action

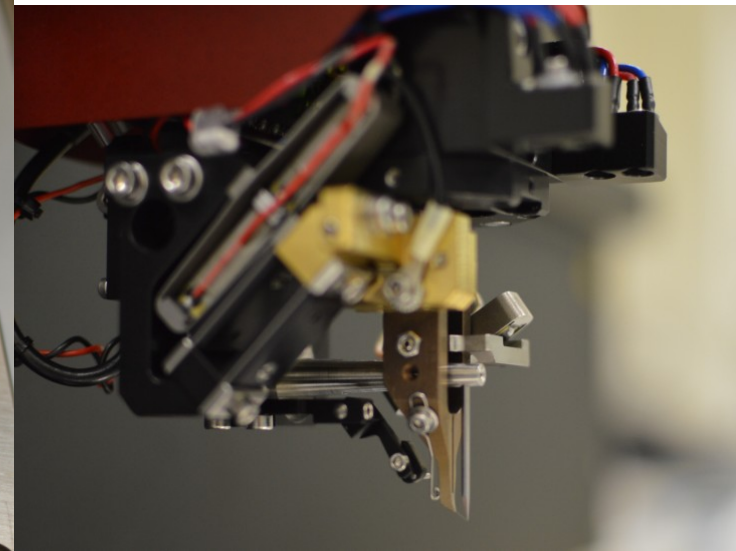# Module construction
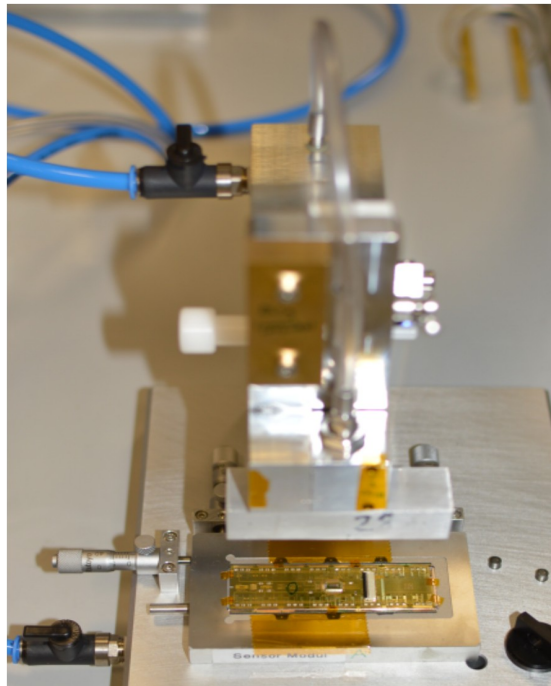
Many module components:

High-density interconnect

Sensor

16 ROCs

Base-strips

- All components are tested upon reception (not covered here)

- Mechanical assembly & wire bonding

Module construction
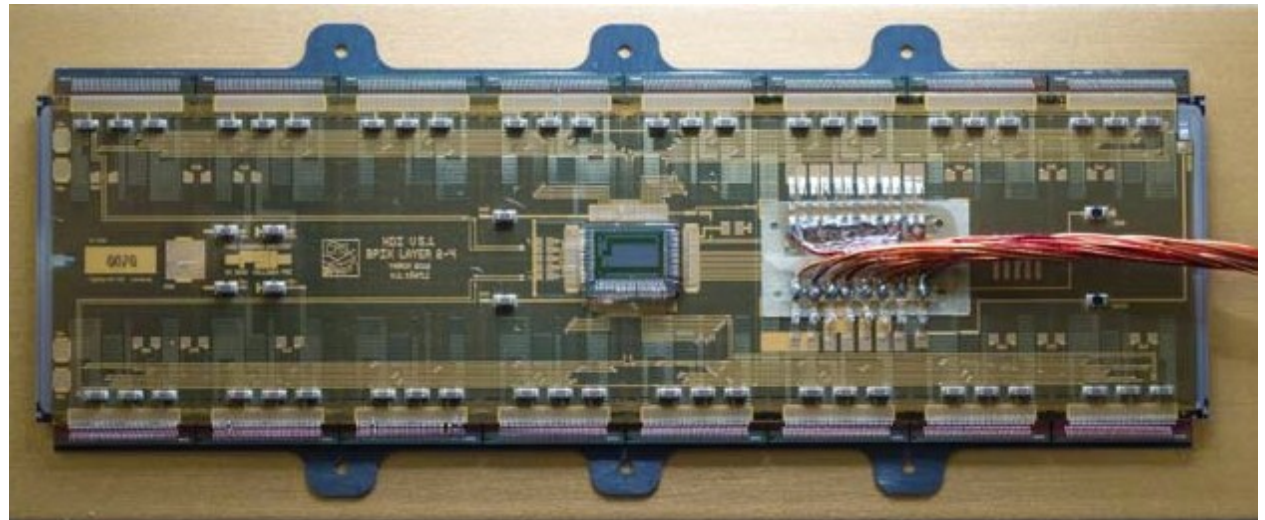
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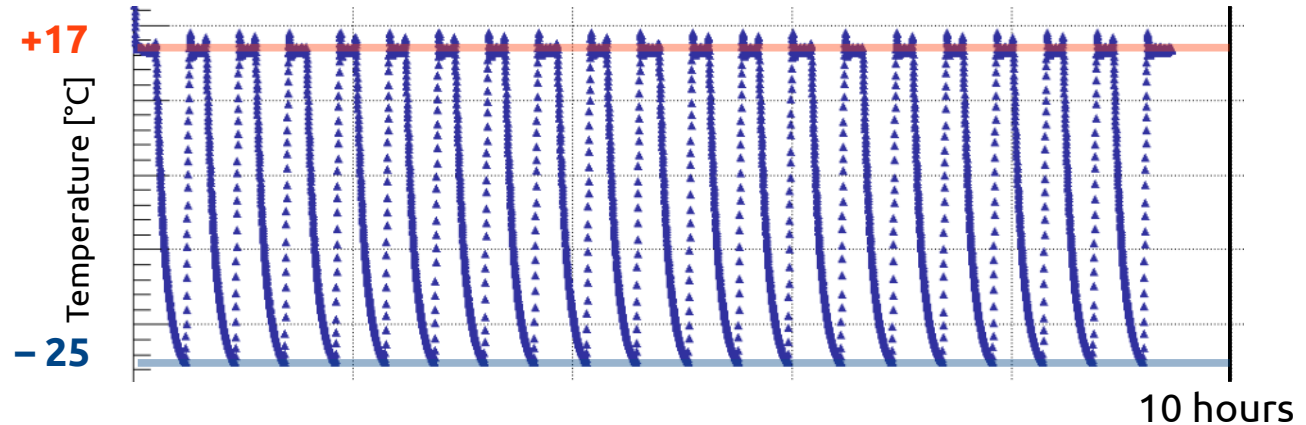High-density interconnect

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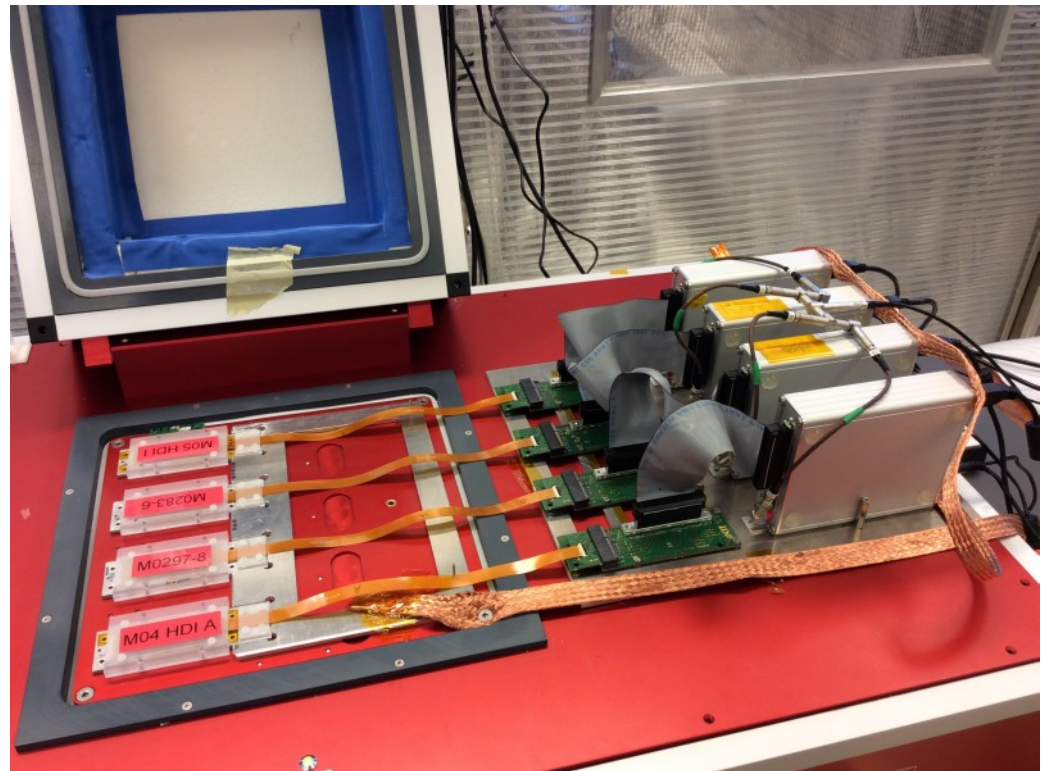- Each module undergoes full functional test after assembly

Thermal cycling

Operating temperatures:

- Sensor max = -5°C
- Cooling = -25°C

Thermal chamber with functional test:

- Thermal cycling (burn-in)
- Measurement of calibration constants at room temperature and -25°C

X-ray calibrations

High-rate x-rays

- Tests if each pixel is responding

Secondary x-rays: fluorescent target

- Tests linearity of response
- Records calibration constants
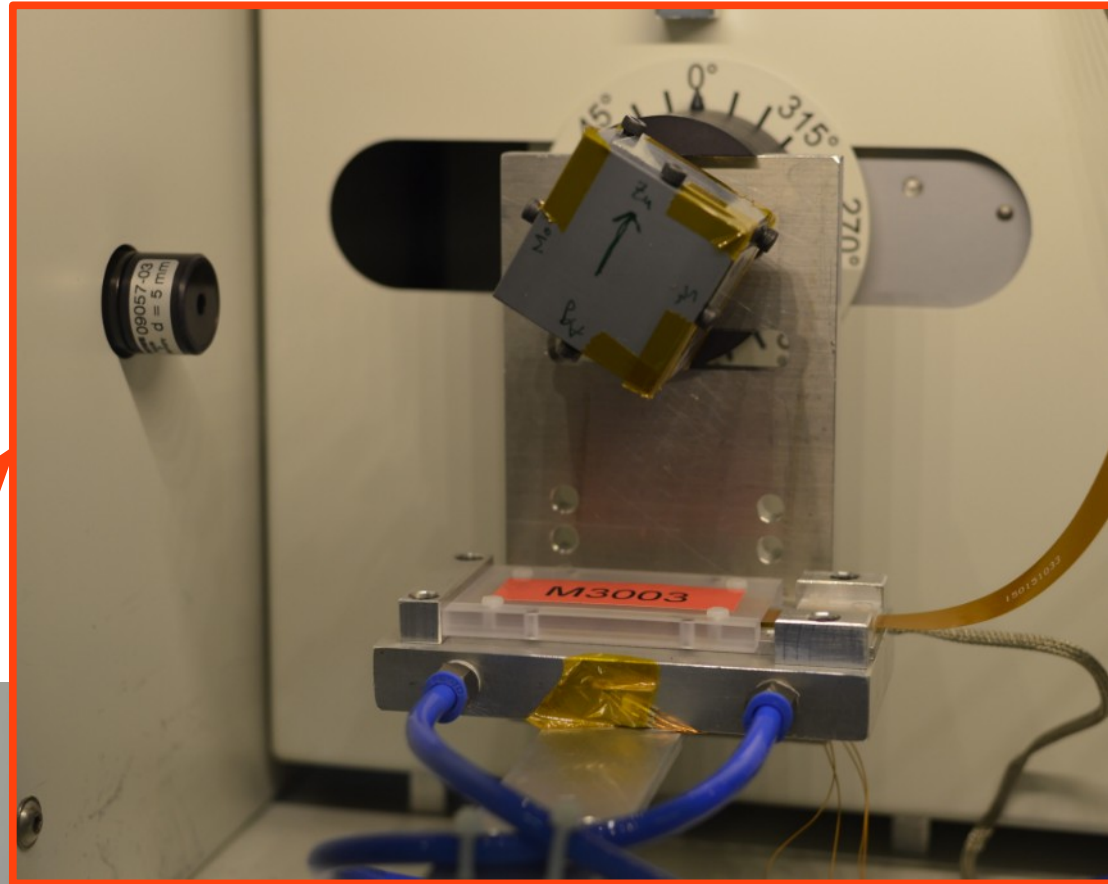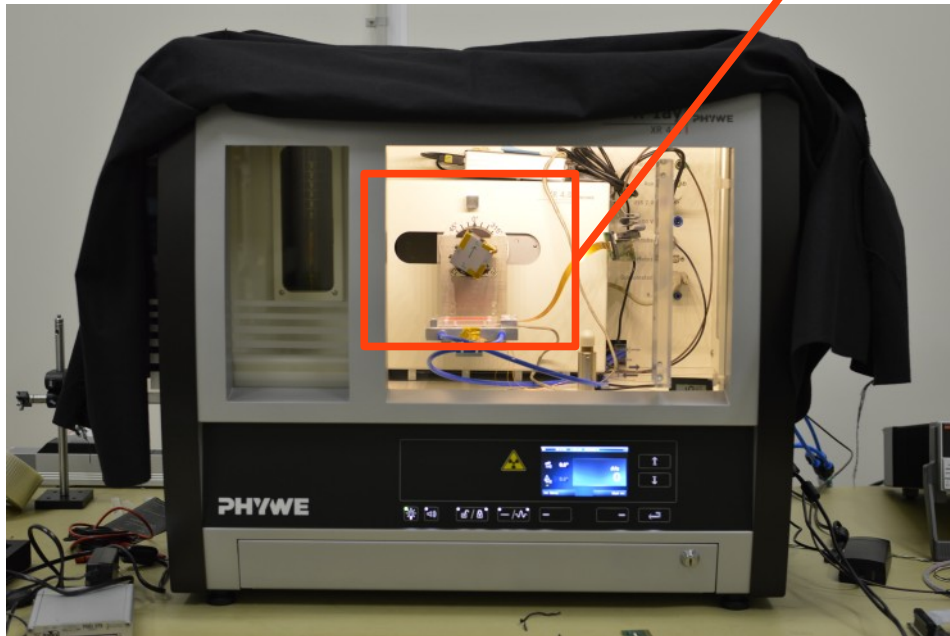
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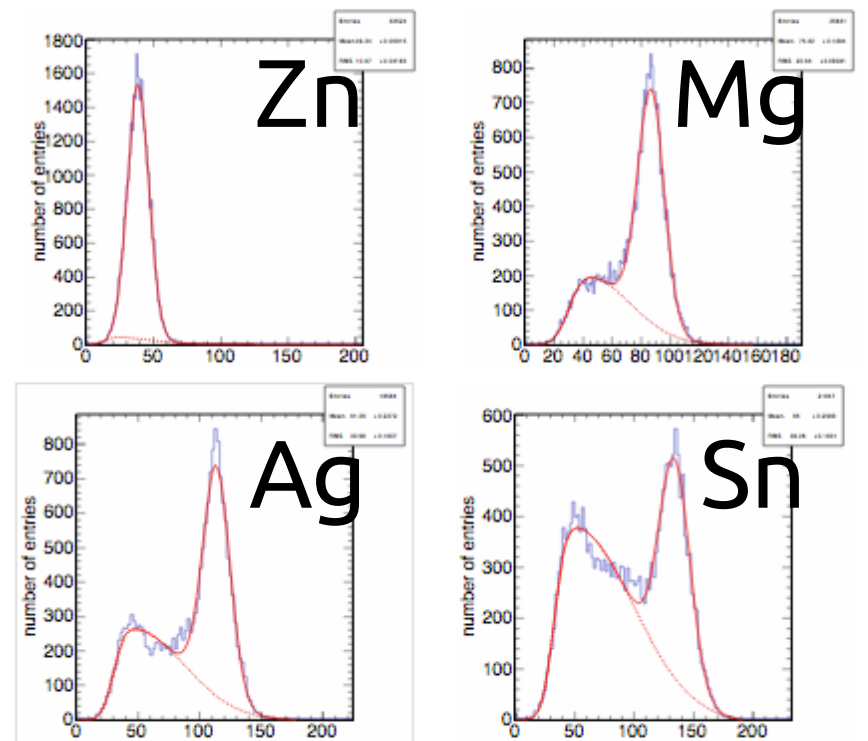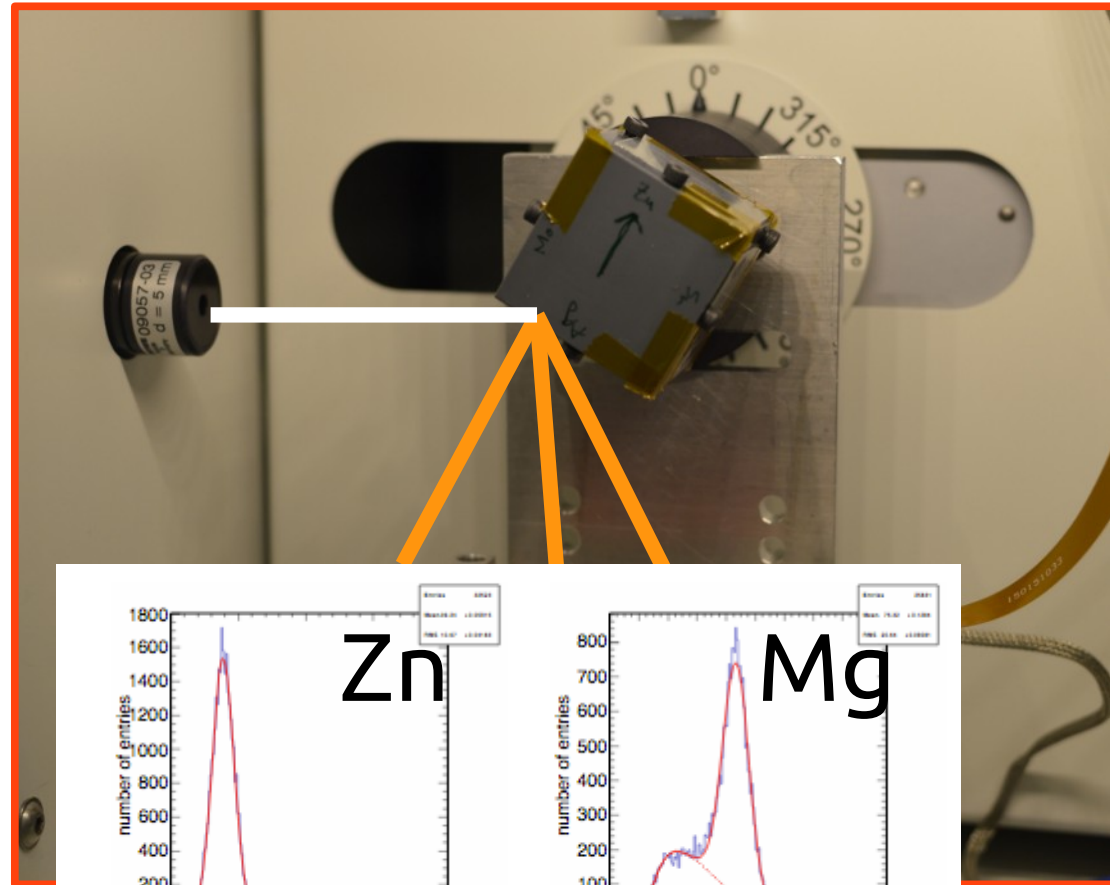
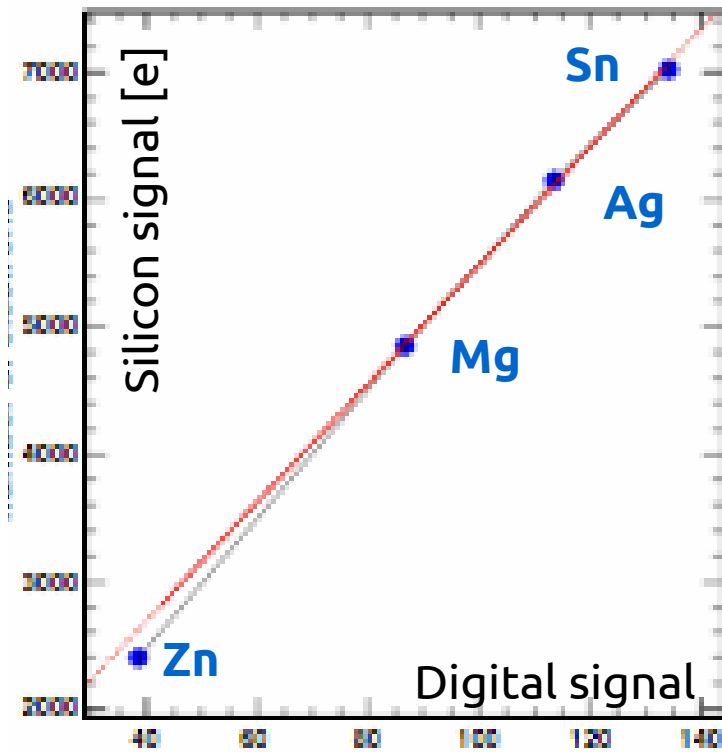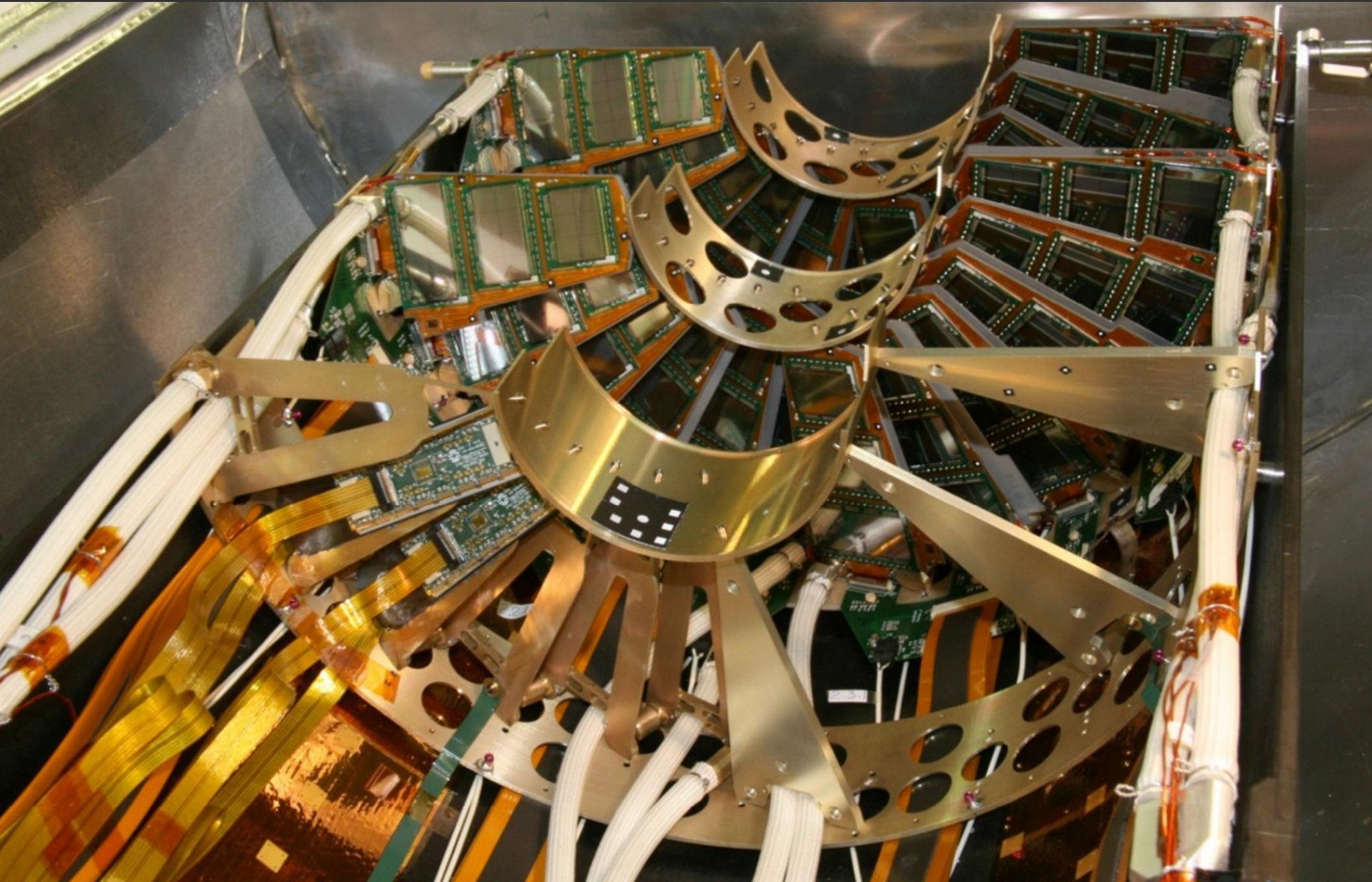# Integration test systems @CERN

- Inside CMS: pilot blade
  - A very realistic... beam test!
  - Small fraction of an upgraded endcap disk
  - Can test integration of DAQ with CMS

- Building 186 (Monday's visit)
  - DAQ intergation and testing
  - Table-system
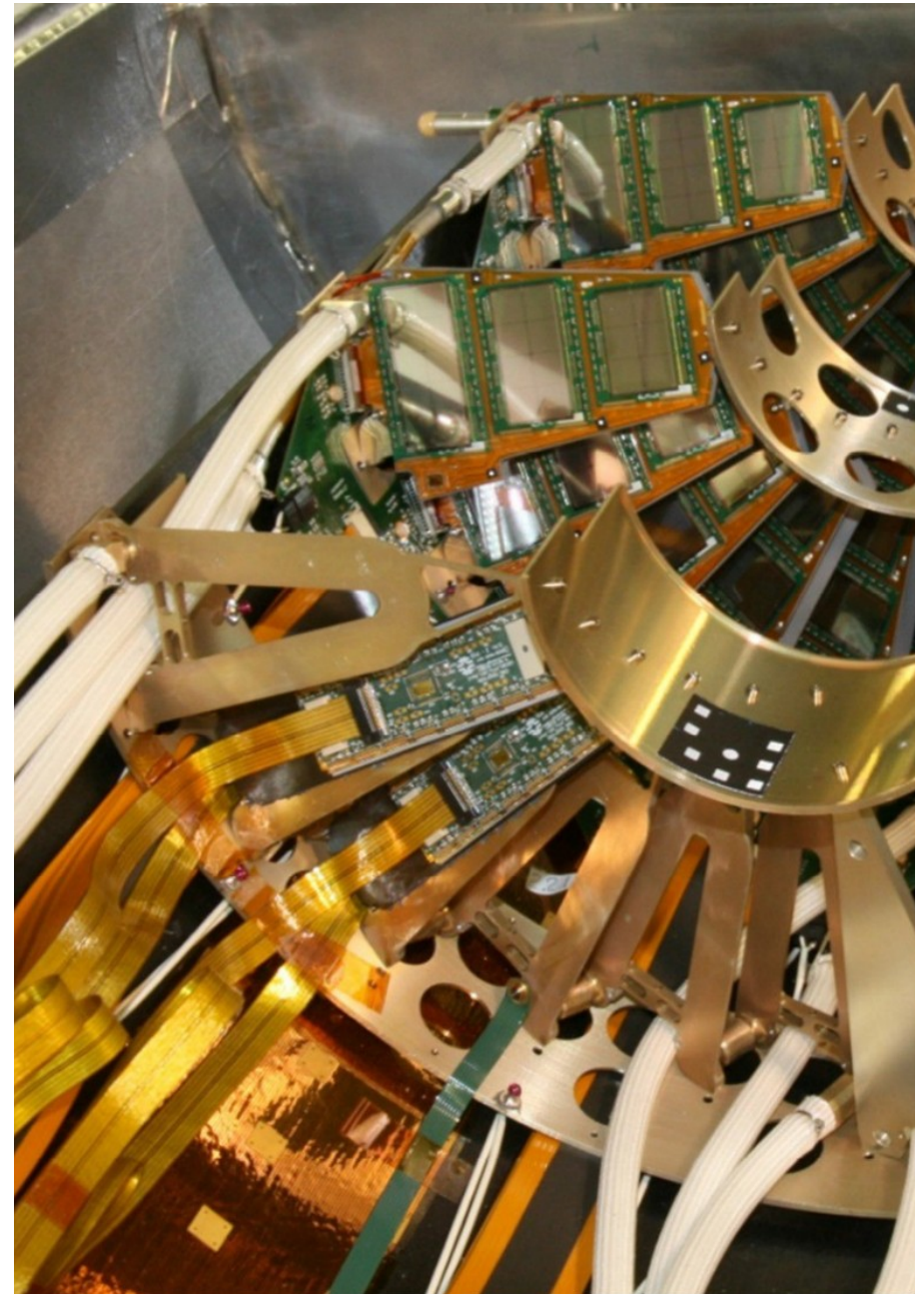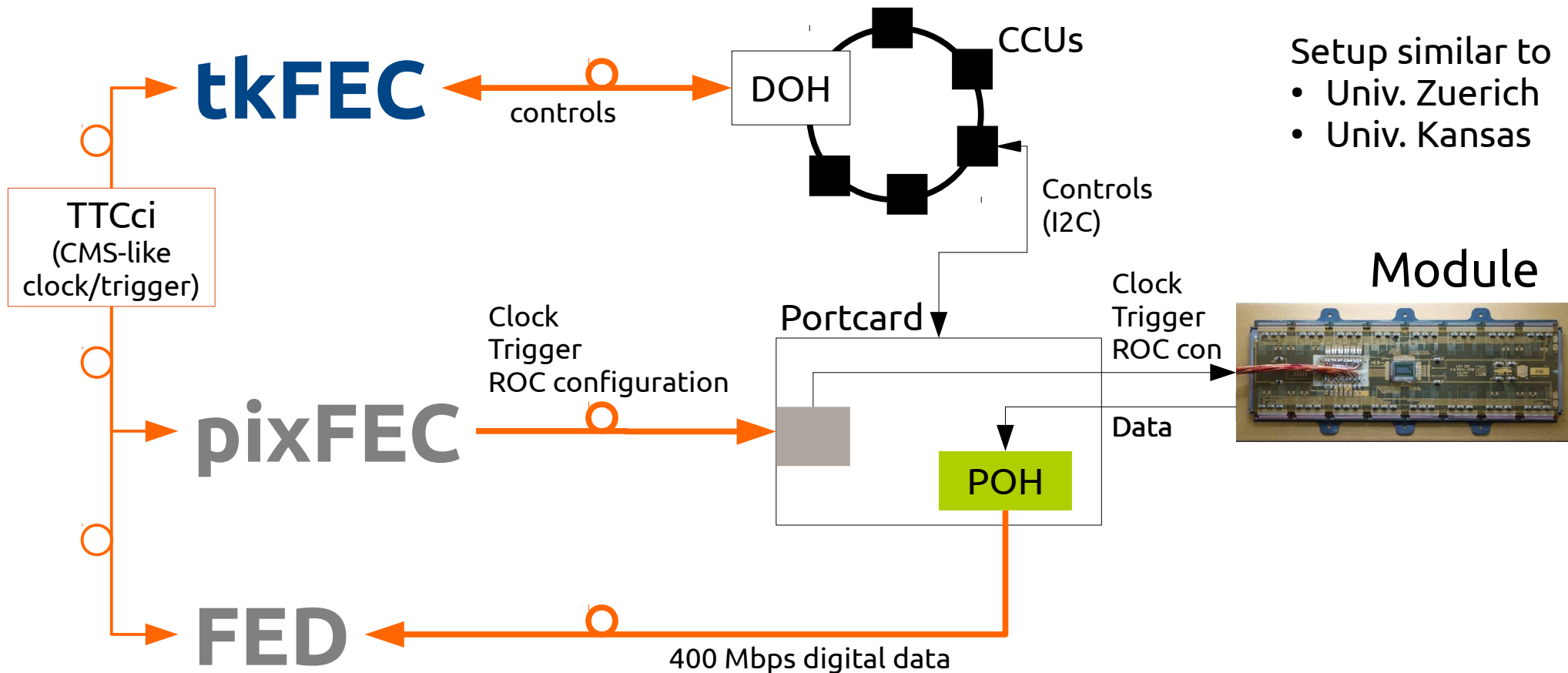
Pilot system

- Current Forward-PIX has room/services for 3 disks, but only 2 have been built

- 8 Phase-1 FPIX modules mounted on 3rd disk

- Exercise and develop detector operation (readout, control, DAQ integration)

- Crucial for seamless transition after upgrade

B186 integration test system

tkFEC

controls

DOH

CCUs

Setup similar to
- Univ. Zuerich
- Univ. Kansas

TTCci
(CMS-like clock/trigger)

Controls (I2C)

Clock
Trigger
ROC configuration

Portcard

Clock
Trigger
ROC con

Module

pixFEC

Data

POH

FED

400 Mbps digital data

Current status
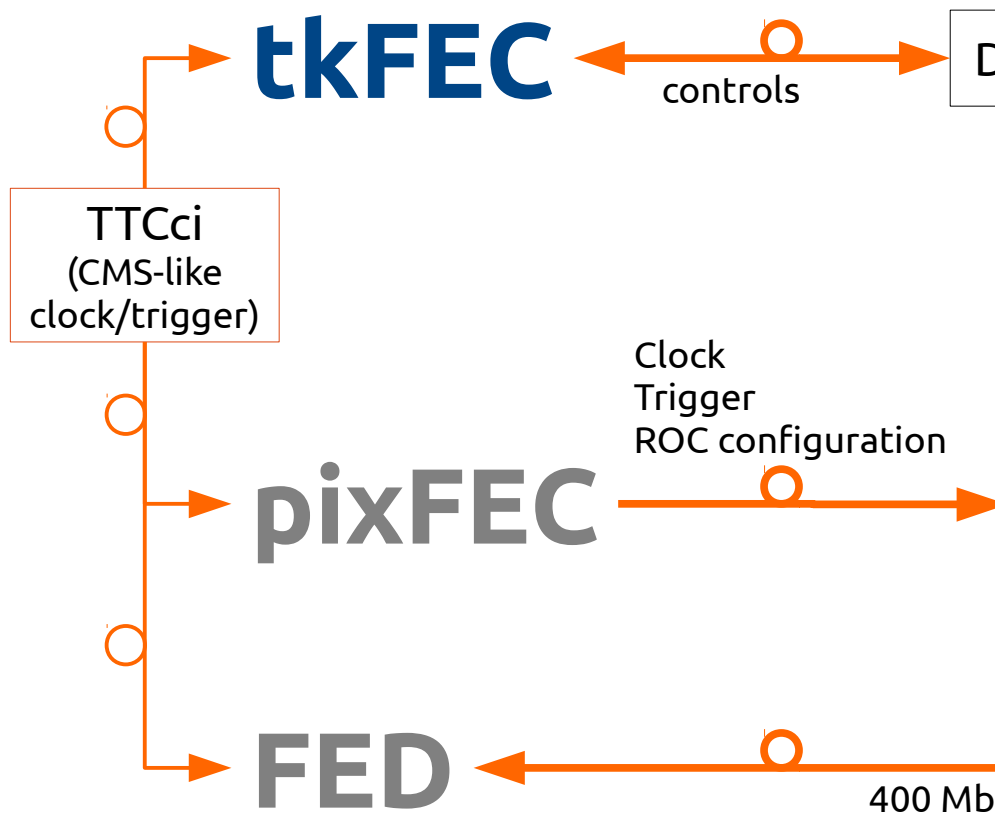## New: µTCA
Old: VME

Software integration tests
Firmware integration tests
Possible to debug the front-end with a scope & probe!
Software development to merge with CMS DAQ code

tkFEC ⟷ ─○─ D...
controls

milar to
Zuerich
Kansas

TTCci
(CMS-like
clock/trigger)

Clock
Trigger
ROC configuration

pixFEC ──○──→

dule

FED ←──○──
400 Mb

tkFEC

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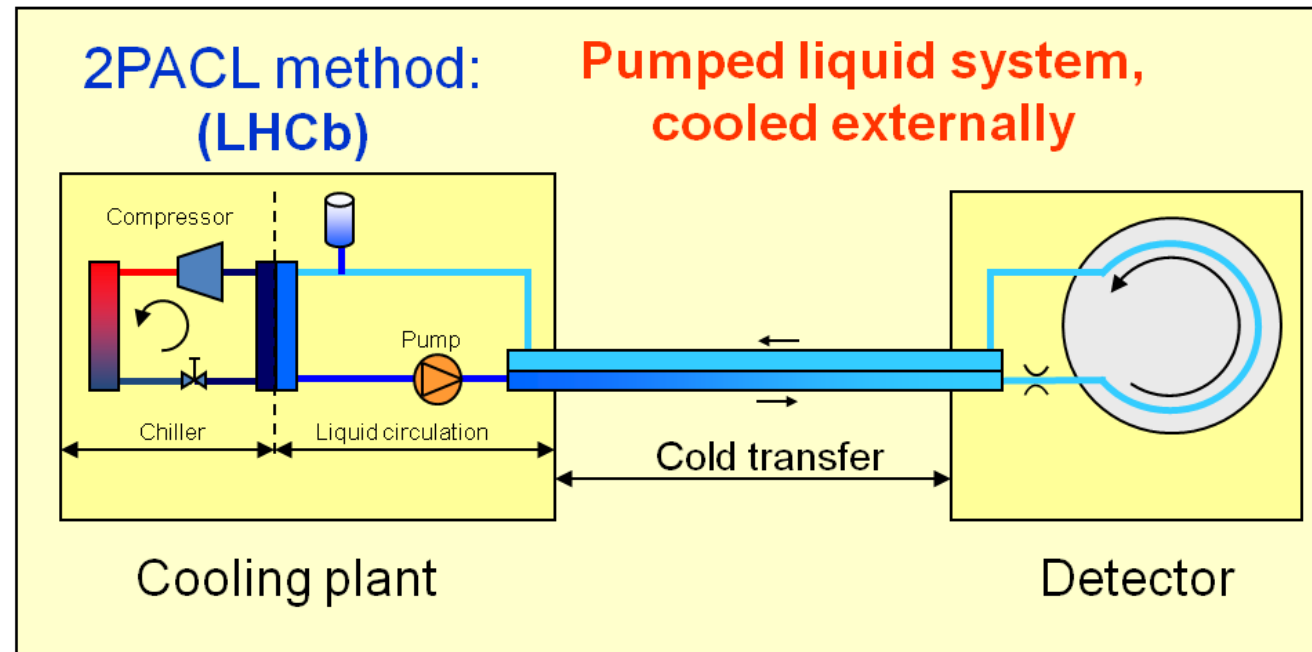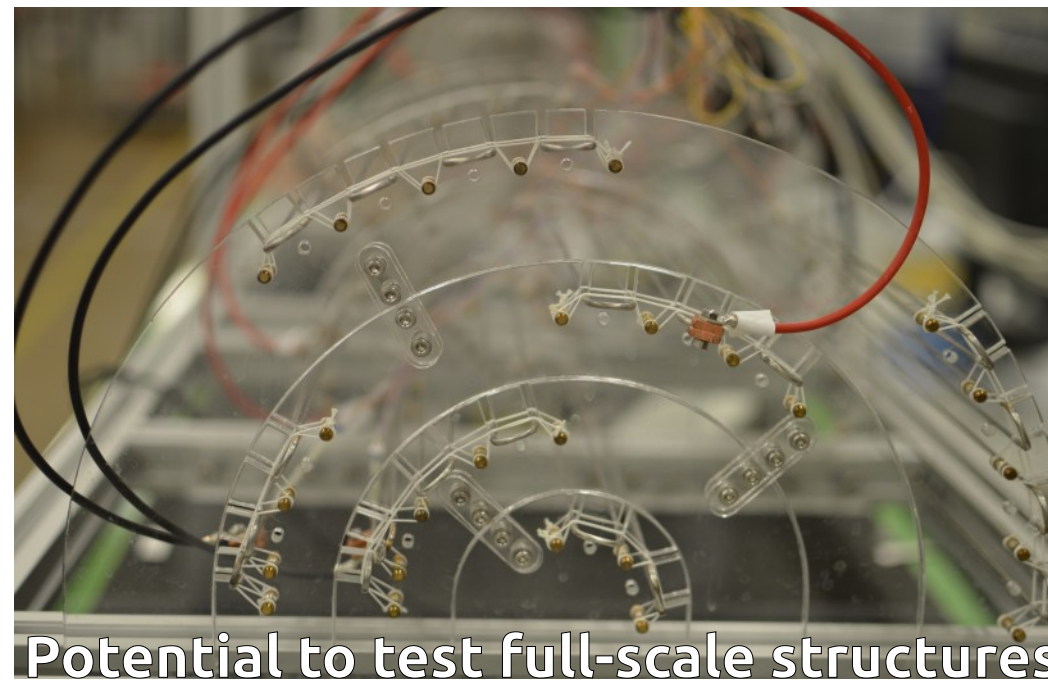
Cooling plant full-scale prototype

Several years of development & construction

- 15 kW plant
- CO_2 evaporative cooling
- Coolant T= -20 °C
- Thin cooling tubes in active region
  - 50 um wall (steel)
  - 80 bar

2PACL method: (LHCb)

Pumped liquid system, cooled externally

Compressor

Pump

Chiller — Liquid circulation

Cold transfer

Cooling plant

Detector

Two more units already installed at CMS!

Potential to test full-scale structures

Next: testing of large structures

- As soon as possible, putting together a full shelf of µTCA boards

- Building the system control/monitoring/safety

- Assessing system stability over time

- Software integration with current DAQ & performance/scalability test

Whole system FED+FEC = ~100 new µTCA boards

- Long-term tests
- Progressively integrate towards the full scale of final DAQ system
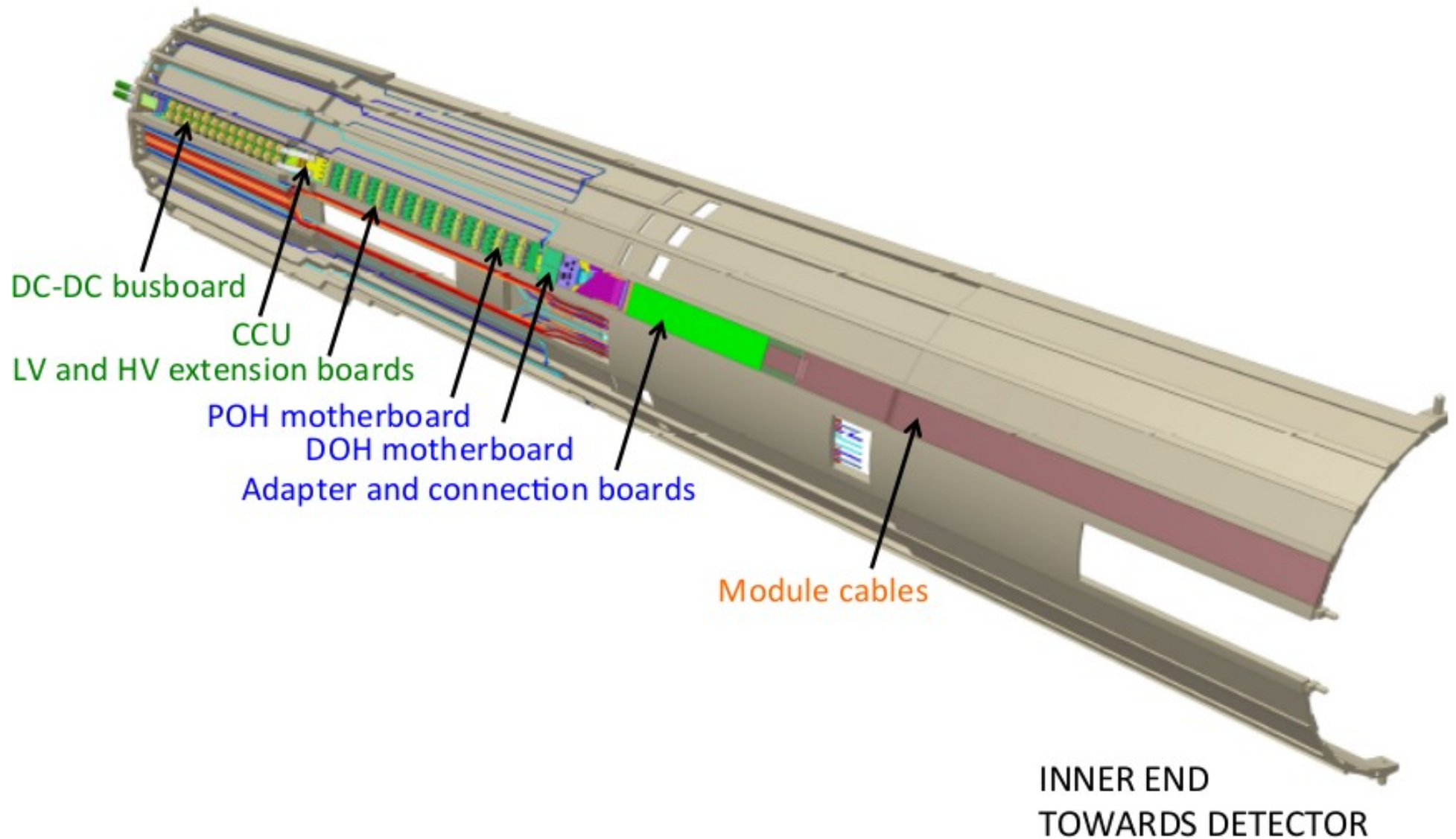
Conclusion and outlook

- CERN hosting a number of production/testing activities in Building 186:

  – Design and construction of cooling plants

  – Module assembly and qualification

  – Integration of DAQ systems

- In the near future, all these activities will converge towards:

  – Testing large-scale systems

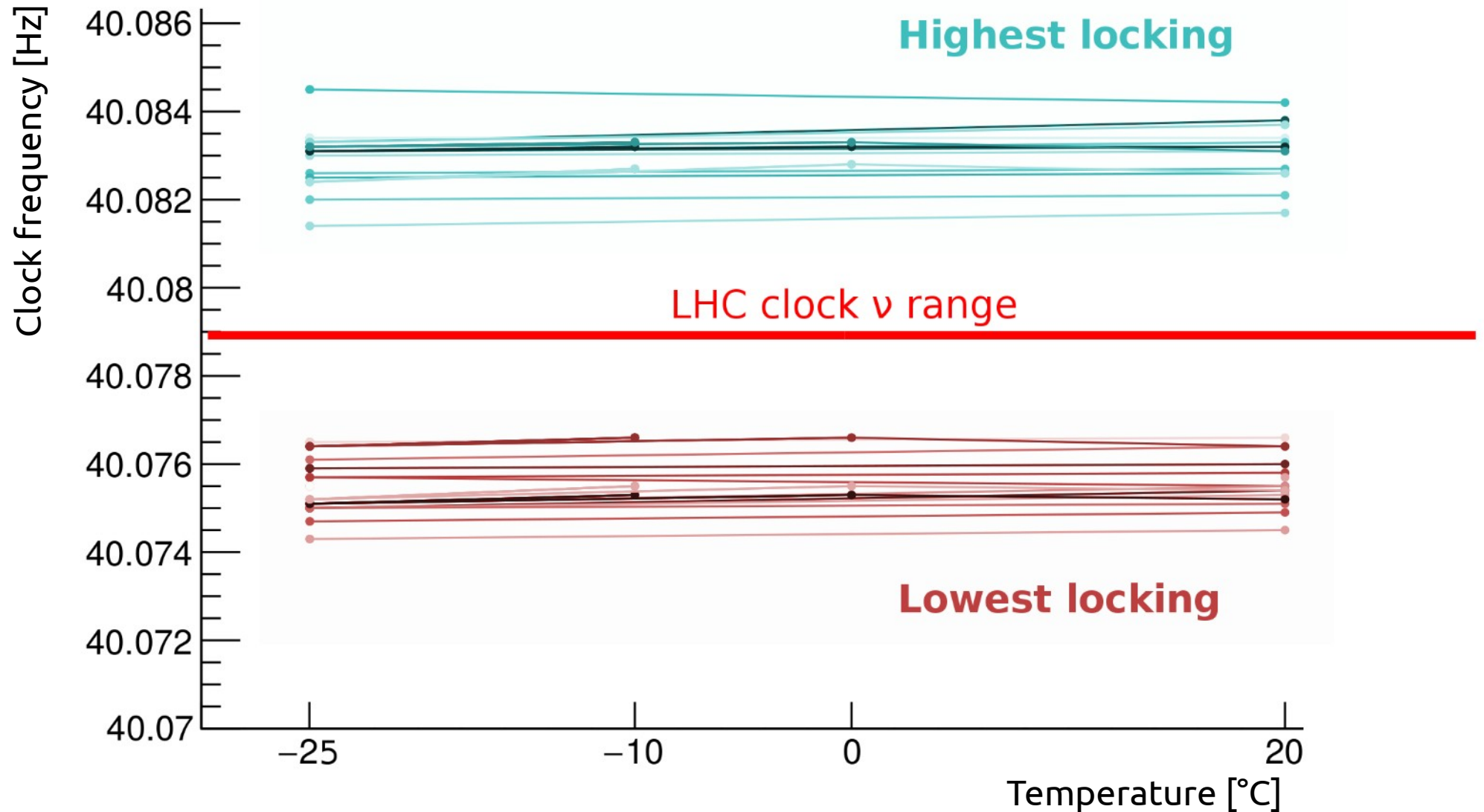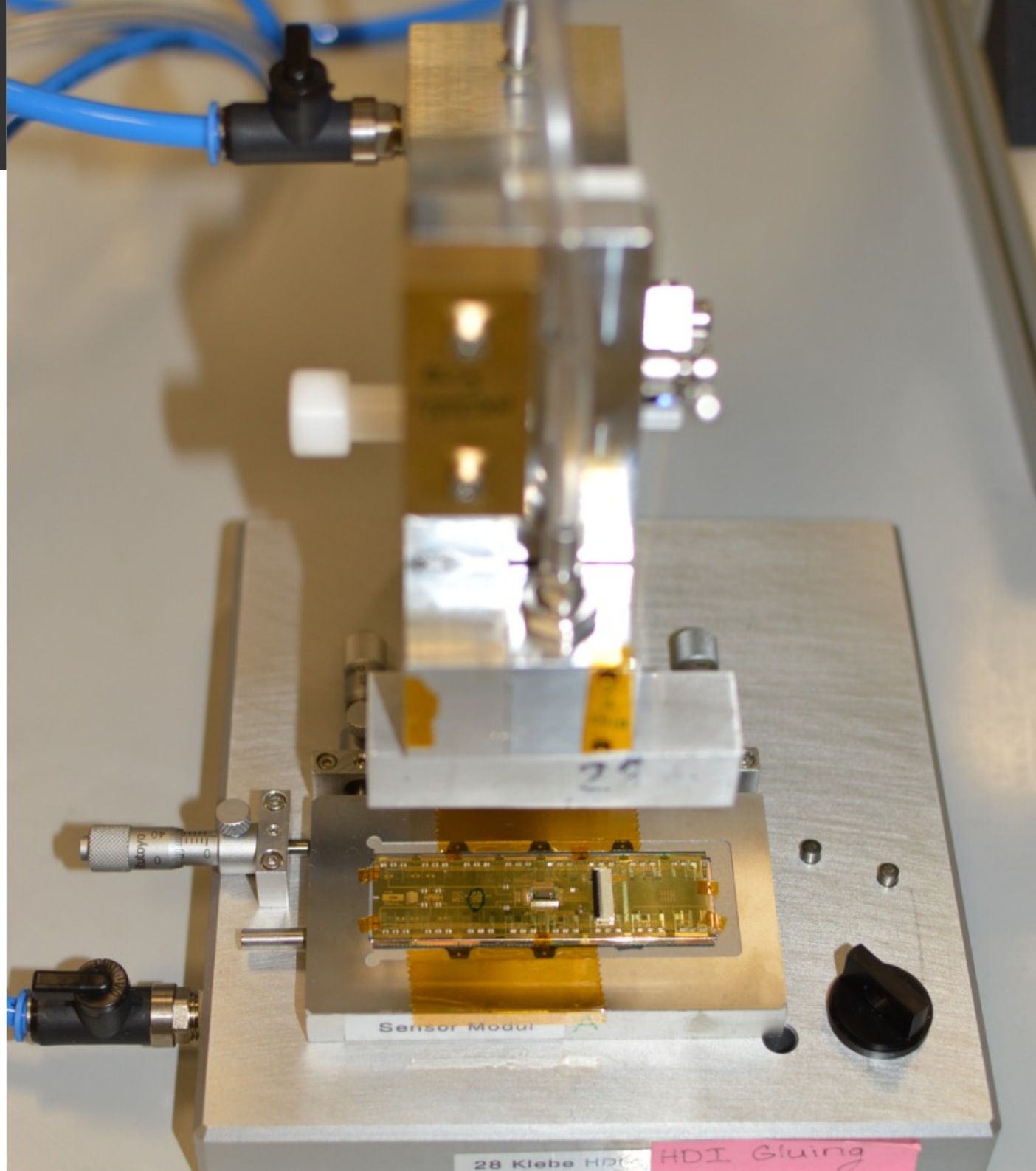 – Detector installation/commissioning at CMS

Questions?

Backup slides

OUTER END
TOWARDS PP0

DC-DC busboard
CCU
LV and HV extension boards
POH motherboard
DOH motherboard
Adapter and connection boards

Module cables

INNER END
TOWARDS DETECTOR

Q-PLL qualification: locking range

48 Q-PLLs, before irradiation
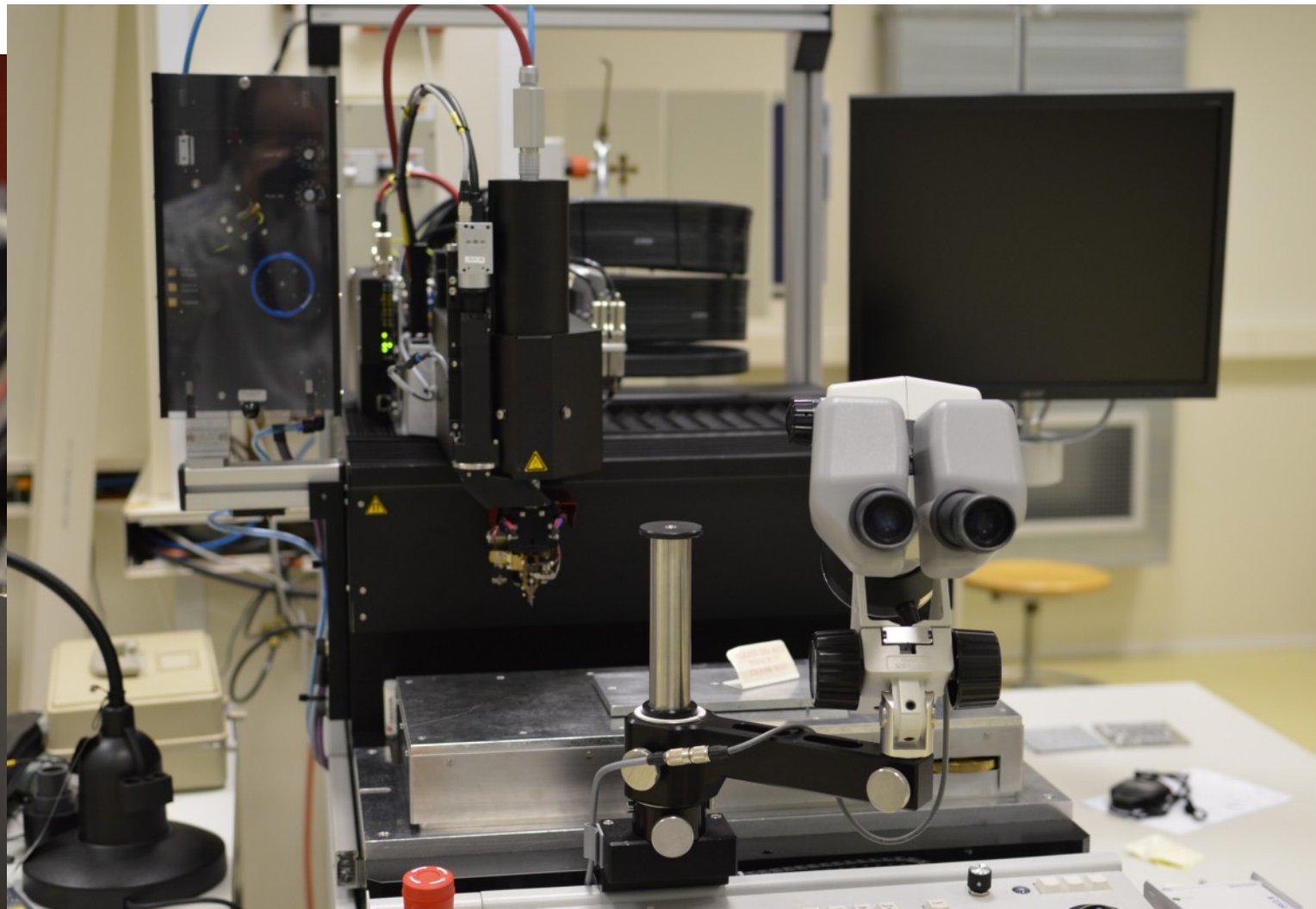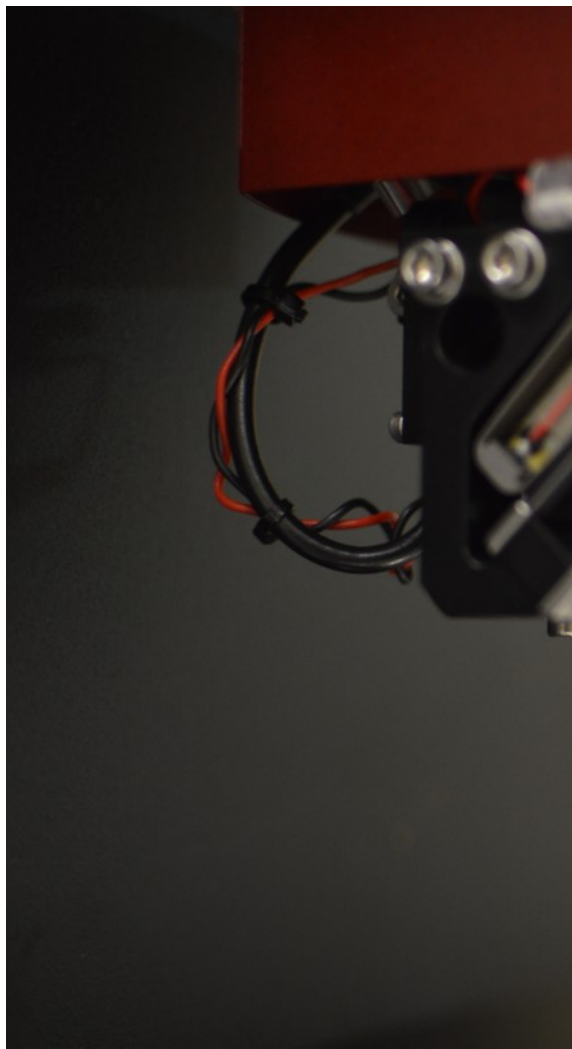
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